## 6W Stereo Class-D Audio Power Amplifier

## Features

- Supply Voltage is $8 \mathrm{~V} \sim \mathbf{2 6 V}$
- Class D operation eliminates heat sink \& reduce power supply requirement
- 20,26, 32, 36, 4 steps gain setting
- 6 W per channel (THD+N=10\%)output power into $8 \Omega$ load at 10 V , Class D output
- MONO function combines two channels' output to supply 12 W into a $4 \Omega$ load at 12 V (THD+N=10\%)
- Adjustable Power limit function plus DC Protection
- Thermal and Over-Current Protections with AutoRecovery option
- TSSOP-28P with thermal pad packages
- QFN4x4-28 with thermal pad packages


## Applications

- LCD Monitor
- AIO


## Simplified Application Circuit



## General Description

The APA2613 is a stereo, high efficiency, Class-D audio amplifier available in TSSOP-28Pand QFN4x4-28A pins packages.
The Class-D power amplifier has higher efficiency compare to the tradition Class-AB power amplifier. The filterfree Class-D architecture eliminates the external low pass filters. The internal gain setting can minimum the external component counts, and for the flexible application the gain can be set to 4 -step 20, 26, 32, 36dB by gain control ins (GAIN0 and GAIN1). The power limit function cans protection the speaker when output signal excess the speaker limit rating.
The integration of Class-D power amplifier is a best solution for power efficiency and lower the total BOM costs. The operating voltage is from 8 V to 26 V . The APA2613 power amplifiers are capable of driving 6 W at $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ into $8 \Omega$ speaker, and provides thermal and over-current protections also can detection the DC that prevent to destroy the speaker voice coil.

## Pin Configuration



ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

## Pin Configuration(Cont.)



## Ordering and Marking Information

|  |  | Package Code <br> R:TSSOP-28P QA: QFN4x4-28 <br> Operating Ambient Temperature Range $\text { I: }-40 \text { to } 85^{\circ} \mathrm{C}$ <br> Handling Code <br> TR : Tape \& Reel <br> Assembly Material <br> G: Halogen and Lead Free Device |
| :---: | :---: | :---: |
| APA2613 R : | .$_{0}^{\text {- }} \begin{gathered}\text { APA2613 } \\ \text { XXXXX }\end{gathered}$ | XXXXX - Date Code |
| APA2613 QA : | Q <br> APA2613 <br> $\times X X X X$ | XXXXX - Date Code |

Note : ANPEC lead-free products contain molding compounds/die attach materials and $100 \%$ matte tin plate termination finish; which are fully compliant with RoHS. ANPEC lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. ANPEC defines "Green" to mean lead-free (RoHS compliant) and halogen free ( Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight).

## Absolute Maximum Ratings (Note 1)

(Over operating free-air temperature range unless otherwise noted.)

| Symbol | Parameter | Rating | Unit |
| :---: | :---: | :---: | :---: |
| $V_{\text {DD }}$ | Supply Voltage (PVDD, AVDD) | -0.3 to 30 | V |
| V | Input Voltage ( $\overline{\mathrm{SD}}$, GAIN0 and GAIN1, MONO and $\overline{\mathrm{FLAG}}$ ) | -0.3 to $\mathrm{V}_{\mathrm{DD}}+0.3$ |  |
|  | PLIMIT | -0.3 to 6.3 |  |
|  | LINP, LINN, RINP, RINN | -0.3 to 6.3 |  |
| TJ | Maximum Junction Temperature | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature Range | -65 to +150 |  |
| $\mathrm{T}_{\text {SDR }}$ | Soldering Temperature Range, 10 Seconds | 260 |  |
| $\mathrm{R}_{\mathrm{L}}$ | STEREO Mode : $\mathrm{V}_{\text {DD }}>15 \mathrm{~V}$ | 4.8 | $\Omega$ |
|  | STEREO Mode: $\mathrm{V}_{\mathrm{DD}} \leqq 15 \mathrm{~V}$ | 3.2 |  |
|  | MONO mode | 3.2 |  |
| PD | Power Dissipation | Internally Limited | W |

Note1: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## Thermal Characteristics

| Symbol | Parameter |  | Typical Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\theta_{\text {JA }}$ | Thermal Resistance -Junction to Ambient ${ }^{\text {(Nole 2) }}$ | TSSOP-28P QFN4x4-28 | $\begin{aligned} & 45 \\ & 40 \\ & \hline \end{aligned}$ | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\text {Jc }}$ | Thermal Resistance -Junction to Case ${ }^{\text {(Note 3) }}$ | TSSOP-28P QFN4x4-28 | $\begin{aligned} & 8 \\ & 7 \\ & \hline \end{aligned}$ |  |

Note 2: $\theta_{\mathrm{JA}}$ is measured with the component mounted on a high effective thermal conductivity test board in free air. The exposed pad of TSSOP-28P is soldered directly on the PCB.
Note 3: The case temperature is measured at the center of the exposed pad on the underside of the TSSOP-28P package.

## Recommended Operating Conditions

| Symbol | Parameter |  | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {DD }}$ | Supply Voltage |  | 8.0 | 26.0 | V |
| $\mathrm{V}_{\mathrm{H}}$ | High Level Threshold Voltage | $\overline{\text { SD }}$ | 2.2 | - |  |
|  |  | GAINO, GAIN1, MONO | 2.0 | - |  |
| $\mathrm{V}_{\mathrm{IL}}$ | Low Level Threshold Voltage | $\overline{\text { SD }}$ | - | 0.8 |  |
|  |  | GAINO, GAIN1, MONO | - | 0.8 |  |
| $\mathrm{T}_{\mathrm{A}}$ | Ambient Temperature Range |  | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{J}}$ | Junction Temperature Range |  | -40 | 125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{R}_{\mathrm{L}}$ | Speaker Resistance |  | 3.5 | - | $\Omega$ |

## Electrical Characteristics

$V_{D D}=12 \mathrm{~V}, G N D=0 \mathrm{~V}, \mathrm{~A}_{\mathrm{V}}=36 \mathrm{~dB}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted).

| Symbol | Parameter | Test Conditions | APA2613 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| $V_{\text {CLAMP }}$ | Regulated Voltage | $\begin{aligned} & \mathrm{I}_{\mathrm{O}}=2 \mathrm{~mA}, \mathrm{~V}_{\mathrm{DD}}=8 \sim 26 \mathrm{~V} \\ & \mathrm{~T}_{\mathrm{J}}=-40^{\circ} \mathrm{C} \sim 125^{\circ} \mathrm{C} \end{aligned}$ | 4.5 | 5 | 5.5 | V |
| $V_{0}$ | Maximum Output Voltage Under PLIMIT Control | $\mathrm{V}_{\text {PLIMIT }}=1 \mathrm{~V}, \mathrm{~V}_{\mathrm{I}}=1 \mathrm{Vrms}$ | 4.6 | 5.5 | 6.1 |  |
| $\mathrm{T}_{\text {sdo }}$ ( ${ }^{\text {a }}$ | Shutdown Turn-On Time | $\overline{\mathrm{SD}}=2.2 \mathrm{~V}$ | - | 16 | - | ms |
| $\mathrm{T}_{\text {SD(OFF) }}$ | Shutdown Turn-Off Time | $\overline{\mathrm{SD}}=0.8 \mathrm{~V}$ | - | 2 | - | $\mu \mathrm{s}$ |
| $1 \mathrm{ID}^{\text {d }}$ | Quiescent Supply Current | No Load | - | 20 | 35 | mA |
| $I_{\text {SD }}$ | Quiescent Supply Current in shutdown mode | $\overline{\mathrm{SD}}=0 \mathrm{~V}$ | - | 10 | 100 | $\mu \mathrm{A}$ |
| 1 | Input Current | $\overline{\text { SD }}$, GAIN0, GAIN1, MONO | - | 5 | 50 |  |
| Fosc | Internal Oscillator Frequency |  | 400 | 500 | 600 | kHz |
| $\mathrm{R}_{\text {DSon }}$ | Static Drain-Source On-State Resistance | $\mathrm{V}_{\mathrm{DD}}=12 \mathrm{~V}, \mathrm{I}=0.5 \mathrm{~A}$ | - | 400 | - | $\mathrm{m} \Omega$ |
| Av | Gain | Gain $0=0$, Gain $1=0$ | - | 20 | - | dB |
|  |  | Gain $0=1$, Gain $1=0$ | - | 26 | - |  |
|  |  | Gain $0=0$, Gain $1=1$ | - | 32 | - |  |
|  |  | Gain $0=1$, Gain $1=1$ | - | 36 | - |  |

## Stereo Mode

$V_{D D}=12 \mathrm{~V}, G N D=0 \mathrm{~V}, \mathrm{~A}_{\mathrm{V}}=36 \mathrm{~dB}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted).

| Symbol | Parameter | Test Conditions |  | APA2613 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| $\mathrm{V}_{\mathrm{DD}}=24 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |
| Crosstalk | Channel Separation | $\mathrm{V}_{\mathrm{o}}=1 \mathrm{Vrms}, \mathrm{F}_{\text {IN }}=1 \mathrm{kHz}$, Gain=20dB |  | - | -85 | - | dB |
| SNR | Signal-To-Noise Ratio | Maximum output at THD $+\mathrm{N}<1 \%$, $\mathrm{F}_{\mathrm{IN}}=1 \mathrm{kHz}$, Gain $=20 \mathrm{~dB}, \mathrm{~A}$-weighted |  | - | 95 | - | dB |
| Attstiutown | Shutdown Attenuation | $\mathrm{F}_{\text {IN }}=1 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {in }}=1 \mathrm{~V}_{\text {PP }}$ |  | - | -100 | - |  |
| I Vos 1 | Offset Voltage | $\mathrm{A}_{\mathrm{v}}=20 \mathrm{~dB}$ |  | - | - | 15 | mV |
| $V_{n}$ | Noise Output Voltage | With A-weighted Filter ( $\mathrm{A}_{v}=20 \mathrm{~dB}$ ) |  | - | 120 | - | $\begin{gathered} \mu \mathrm{V} \\ (\mathrm{rms}) \end{gathered}$ |
| $\mathrm{V}_{\mathrm{DD}}=12 \mathrm{~V} \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |
| Po | Output Power | $\begin{aligned} & \text { THD+N }=1 \% \\ & \mathrm{~F}_{\mathrm{IN}}=1 \mathrm{kHz} \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=8 \Omega$ | - | 7 | - | W |
|  |  | $\begin{aligned} & \text { THD }+\mathrm{N}=10 \% \\ & \mathrm{~F}_{\mathrm{IN}}=1 \mathrm{kHz} \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=8 \Omega$ | - | 8.5 | - |  |
| THD + N | Total Harmonic Distortion Plus Noise | $\mathrm{F}_{\text {IN }}=1 \mathrm{kHz}$ | $\begin{aligned} & \hline \mathrm{R}_{\mathrm{L}}=8 \Omega \\ & \mathrm{P}_{\mathrm{O}}=4 \mathrm{~W} \end{aligned}$ | - | 0.1 | - | \% |
| Crosstalk | Channel Separation | $\mathrm{V}_{\mathrm{O}}=1 \mathrm{Vrms}, \mathrm{F}_{\text {IN }}=1 \mathrm{kHz}$, Gain=20dB |  | - | -90 | - | dB |
| SNR | Signal-To-Noise Ratio | Maximum output at THD $+\mathrm{N}<1 \%$, $\mathrm{F}_{\mathrm{IN}}=1 \mathrm{kHz}$, Gain $=20 \mathrm{~dB}, \mathrm{~A}$-weighted |  | - | 95 | - |  |
| Att $_{\text {suutdown }}$ | Shutdown Attenuation | $\mathrm{F}_{\mathrm{IN}}=1 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {in }}=1 \mathrm{~V}_{\text {PP }}$ |  | - | -100 | - |  |
| I $\mathrm{V}_{\text {os }}$ l | Offset Voltage | $\mathrm{A}_{\mathrm{v}}=20 \mathrm{~dB}$ |  | - | - | 15 | mV |
| $\mathrm{V}_{\mathrm{n}}$ | Noise Output Voltage | With A-weighted Filter ( $\mathrm{A}_{V}=20 \mathrm{~dB}$ ) |  | - | 120 | - | $\mu \mathrm{V}$ (rms) |

Mono Mode
$V_{D D}=12 \mathrm{~V}, G N D=0 \mathrm{~V}, \mathrm{~A}_{\mathrm{V}}=36 \mathrm{~dB}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted).

| Symbol | Parameter | Test Conditions |  | APA2613 |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| $\mathrm{V}_{\mathrm{DD}}=12 \mathrm{~V} \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |
| Po | Output Power | $\begin{aligned} & \text { THD+N }=1 \% \\ & \mathrm{~F}_{\text {IN }}=1 \mathrm{kHz} \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=4 \Omega$ | - | 9 | - | W |
|  |  | $\begin{aligned} & \text { THD }+\mathrm{N}=10 \% \\ & \mathrm{~F}_{\mathrm{IN}}=1 \mathrm{kHz} \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=4 \Omega$ | - | 12 | - |  |
| THD+N | Total Harmonic Distortion Plus Noise | $\mathrm{F}_{\mathrm{in}}=1 \mathrm{kHz}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=4 \Omega \\ & \mathrm{P}_{\mathrm{O}}=6 \mathrm{~W} \\ & \hline \end{aligned}$ | - | 0.1 | - | \% |
| SNR | Signal-To-Noise Ratio | Maximum output at THD $+\mathrm{N}<1 \%$, $\mathrm{F}_{\mathrm{IN}}=1 \mathrm{kHz}$, Gain $=20 \mathrm{~dB}, \mathrm{~A}$-weighted |  | - | 95 | - | dB |
| Attstutown | Shutdown Attenuation | $\mathrm{F}_{\text {IN }}=1 \mathrm{kHz}, \mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {in }}=1 \mathrm{Vrms}$ |  | - | -100 | - |  |
| Vos | Offset Voltage | $\mathrm{A}_{\mathrm{V}}=20 \mathrm{~dB}$ |  | - | - | 15 | mV |
| $\mathrm{V}_{\mathrm{n}}$ | Noise Output Voltage | With A-weighted Filter ( $\mathrm{A}_{\mathrm{v}}=20 \mathrm{~dB}$ ) |  | - | 120 | - | $\mu \mathrm{V}$ (rms) |

## Typical Operating Characteristics



## Typical Operating Characteristics




THD+N vs. Output Power


THD+N vs. Output Power



THD+N vs. Output Power


## Typical Operating Characteristics




Frequency Response




## Typical Operating Characteristics



PSRR vs. Frequency


Shutdown Attenuation vs.


Crosstalk vs. Frequency


PSRR vs. Frequency


Supply Current vs. Supply Voltage


## Typical Operating Characteristics



## Pin Description

| PIN |  |  | I/O/P | FUNCTION |
| :---: | :---: | :---: | :---: | :---: |
| NO. |  | NAME |  |  |
| $\begin{gathered} \hline \text { TSSOP } \\ \text {-28P } \end{gathered}$ | $\begin{gathered} \text { QFN4x4 } \\ -28 \end{gathered}$ |  |  |  |
| 1 | 4 | $\overline{\mathrm{SD}}$ | I | Shutdown logic input for audio amp (Low=outputs disabled, High=output enabled). TTL logic levels with compliance to AVDD. |
| 2 | 5 | $\overline{\text { FLAG }}$ | O | Protection flag output (open drain). Connecting FLAG and SD can be set to auto-recovery. Otherwise need to reset by cyding AVDD |
| 3 | 6 | LINP | I | Positive audio input for left channel. Biased at $\mathrm{V}_{\text {clamp }} / 2$. |
| 4 | 7 | LINN | 1 | Negative audio input for left channel. Biased at $\mathrm{V}_{\text {CLAMP }} / 2$. |
| 5 | 9 | GAIN0 | 1 | Gain select least significant bit. TTL logic levels with compliance to AVDD. |
| 6 | 10 | GAIN1 | 1 | Gain select least significant bit. TTL logic levels with compliance to AVDD. |
| 7 | 11 | AVDD | P | Analog supply. |
| 8 | 12 | AGND | P | Analog signal ground. Connect to the thermal pad. |
| 9 | 13 | VCLAMP | 0 | Regulated voltage, Nominal voltage is 5 V . |
| 10 | 14 | PLIMIT | I | Power limit level adjust. Connect a resistor divider from VCLAMP to GND to set power limit. Connect directly to VCLAMP for no power limit. |
| 11 | 15 | RINN | I | Negative audio input for right channel. Biased at $\mathrm{V}_{\text {cLAMP }} / 2$. |
| 12 | 16 | RINP | I | Positive audio input for right channel. Biased at $\mathrm{V}_{\text {CLAmP }} / 2$. |
| 13 | 8, 17 | NC |  | Not connected. |
| 14 | 18 | MONO | 1 | Parallel BTL mode switch. |
| 15,16 | 19 | RPVDD | P | Power supply for right channel H-bridge. Right channel and left channel power supply inputs are connected internally. |
| 17 | 20 | RBSP | 1 | Bootstrap I/O for right channel, positive high-side FET. |
| 18 | 21 | ROUTP | O | Class-D H-bridge positive output for right channel. |
| 19, 24 | 22, 28, 25 | PGND | P | Power ground for the H-bridges. |
| 20 | 23 | ROUTN | $\bigcirc$ | Class-D H-bridge negative output for right channel. |
| 21 | 24 | RBSN | I | Bootstrap I/O for right channel, negative high-side FET. |
| 22 | 26 | LBSN | 1 | Bootstrap I/O for left channel, negative high-side FET. |
| 23 | 27 | LOUTN | O | Class-D H-bridge negative output for left channel. |
| 25 | 1 | LOUTP | O | Class-D H-bridge positive output for left channel. |
| 26 | 2 | LBSP | 1 | Bootstrap I/O for left channel, positive high-side FET. |
| 27,28 | 3 | LPVDD | P | Power supply for left channel H-bridge. Right channel and left channel power supply inputs are connected internally. |

## Block Diagram



Typical Application Circuit


## Function Description

Class-D Operation


Figure1. The APA2613 Output Waveform

The APA2613 uses a modulation scheme that allows operation without the classic LC reconstruction filter when the amp is driving an inductive load. Each output is switching from 0 volts to the supply voltage. The $\mathrm{V}_{\text {outp }}$ and $\mathrm{V}_{\text {outn }}$ are in phase with each other with no input so that there is little or no current in the speaker. The duty cycle of $\mathrm{V}_{\text {outp }}$ is greater than $50 \%$ and $\mathrm{V}_{\text {outn }}$ is less than $50 \%$ for positive output voltages. The duty cycle of $\mathrm{V}_{\text {outp }}$ is less than $50 \%$ and $\mathrm{V}_{\text {outn }}$ is greater than $50 \%$ for negative output voltages. The voltage across the load sits at 0 V throughout most of
the switching period, reducing the switching current, which reduces any $I^{2} R$ losses in the load.
Gain Setting Operation

| GAIN1 | GAIN0 | Gain | $\operatorname{Ri}(\Omega)$ |
| :---: | :---: | :---: | :---: |
| 0 | 0 | 20 dB | 60 k |
| 0 | 1 | 26 dB | 30 k |
| 1 | 0 | 32 dB | 15 k |
| 1 | 1 | 36 dB | 9 k |

Table 1: The Gain Setting
The APA2613's gain can be set by GAIN0, GAIN1. The detail gain setting value is list at table 1.

## Shutdown Operation

In order to reduce power consumption while not in use, the APA2613 contains a shutdown function to externally turn off the amplifier bias circuitry. This shutdown feature turns the amplifier off when logic low is placed on the $\overline{\mathrm{SD}}$ pin for APA2613. The trigger point between a logic high and logic low level is typically 2.2 V . It is best to switch between ground and the supply voltage VDD to provide maximum device performance. By switching the $\overline{\mathrm{SD}}$ pin to low level, the amplifier enters a low-consumption- current state, $I_{D D}$ for APA2613 is in shutdown mode. On normal operating, APA2613's $\overline{\mathrm{SD}}$ pin should pull to high level to keeping the IC out of the shutdown mode. The $\overline{S D}$ pin should be tied to a definite voltage to avoid unwanted state changes.

## Power Limit Operation

The voltage at pin 10 can used to limit the power to levels below that which is possible based on the supply rail. Add a resistor divider from Vclamp to ground to set the voltage at the PLIMIT pin. An external reference may also be used if tighter tolerance is required. Also add a $1 \mu \mathrm{~F}$ capacitor from pin 10 to ground.

## Function Description (Cont.)

## Power Limit Operation (Cont.)

The PLIMIT circuit sets a limit on the output peak-to-peak voltage. The limiting is done by limiting the duty cycle to fixed maximum value. This limit can be thought of as a "virtual" voltage rail which is lower than the supply connected to PVDD. This "virtual" rail is 5.6 times the voltage at the PLIMIT pin. This output voltage can be used to calculate the maximum output power for a given maximum input voltage and speaker impedance.

$$
\mathrm{V}_{\mathrm{P}}=5.6 \times \text { PLIMIT voltage if PLIMIT }<2.5 \mathrm{~V}
$$

| Test Conditions | PLIMIT <br> Voltage | MAX Output Power @ <br> THD $+\mathrm{N}=10 \%$ |
| :---: | :---: | :---: |
| $\mathrm{PVDD}=12 \mathrm{~V}, \mathrm{RI}=8 \Omega$ | 1.05 V | 2 W |
| $\mathrm{PVDD}=12 \mathrm{~V}, \mathrm{RI}=8 \Omega$ | 1.37 V | 3 W |
| $\mathrm{PVDD}=12 \mathrm{~V}, \mathrm{Rl}=8 \Omega$ | 1.59 V | 4 W |
| $\mathrm{PVDD}=12 \mathrm{~V}, \mathrm{Rl}=8 \Omega$ | 1.78 V | 5 W |
| $\mathrm{PVDD}=12 \mathrm{~V}, \mathrm{Rl}=4 \Omega$ | 0.77 V | 2 W |
| $\mathrm{PVDD}=12 \mathrm{~V}, \mathrm{Rl}=4 \Omega$ | 0.96 V | 3 W |
| $\mathrm{PVDD}=12 \mathrm{~V}, \mathrm{Rl}=4 \Omega$ | 1.15 V | 4 W |
| $\mathrm{PVDD}=12 \mathrm{~V}, \mathrm{Rl}=4 \Omega$ | 1.3 V | 5 W |

Table2. PLIMIT Typical Operation

## VCLAMP Supply

The VCLAMP is used to power the gates of the output full bridge transistors. It can also be used to supply the PLIMIT voltage divider circuit. Add a $1 \mu \mathrm{~F}$ capacitor to ground at this pin.

## Stereo/mono switching Operation

APA2613 offers the feature of Stereo operation with two outputs of each channel connected directly. If the MONO pin (pin 14) is tied high, the positive and negative outputs of each channel (left and right) are synchronized and in phase. To operate in this mono mode, apply the input signal to the RIGHT input and place the speaker between the LEFT and RIGHT outputs. Connect the positive and negative output together for best efficiency.
MONO mode can increase more output power compare to the stereo mode single channel's output power.

## DC Detect

When a DC signal applies to the input of APA2613 and the time excesses 500ms, the APA2613's DC detect fault will be reported on the $\overline{F L A G}$ pin as a low state. The DC Detect fault will also cause the amplifier to shutdown by changing the state of the outputs to $\mathrm{Hi}-\mathrm{Z}$. To clear the DC Detect it is necessary to cycle the PVDD supply. Cycling $\overline{\mathrm{SD}}$ will NOT clear a DC detect fault.

## Over-Current Protection

APA2613 has protection from over-current conditions caused by a short circuit on the output stage. The short circuit protection fault is reported on the $\overline{F L A G}$ pin as a low state. The amplifier outputs are switched to a $\mathrm{Hi}-\mathrm{Z}$ state when the short circuit protection latch is engaged. The latch can be cleared by cycling the $\overline{\mathrm{SD}}$ pin through the low state.
Connect $\overline{F L A G}$ to $\overline{\mathrm{SD}}$ pin, the over current protection will be auto recovery.

## Thermal Protection

Thermal protection on the APA2613 prevents damage to the device when the internal die temperature exceeds $150^{\circ} \mathrm{C}$. There is a $\pm 15^{\circ} \mathrm{C}$ tolerance on this trip point from device to device. Once the die temperature exceeds the thermal set point, the device enters into the shutdown state and the outputs are disabled. This is not a latched fault. The thermal fault is cleared once the temperature of the die is reduced by $15^{\circ} \mathrm{C}$. The device begins normal operation at this point with no external system interaction. Thermal protection faults are NOT reported on the $\overline{F L A G}$ terminal.

## Application I nformation

## Input Resistance, $\mathbf{R}_{\mathrm{i}}$

Changing the gain setting can vary the input resistance of the amplifier from its smallest value, $9 \mathrm{k} \Omega \pm 20 \%$, to the largest value, $60 \mathrm{k} \Omega \pm 20 \%$. As a result, if a single capacitor is used in the input high-pass filter, the -3 dB or cutoff frequency may change when changing gain steps.

## Input Capacitor, $\mathrm{C}_{\mathrm{i}}$

In the typical application, an input capacitor $C_{i}$ is required to allow the amplifier to bias the input signal to the proper dc level for optimum operation. In this case, $C_{i}$ and the input impedance of the amplifier $\left(R_{1}\right)$ form a high-pass filter with the corner frequency determined in Equation 1.

$$
\begin{equation*}
\mathrm{f}_{\mathrm{C}(\text { hipass })}=\frac{1}{2 \pi \mathrm{R}_{\mathrm{i}} \mathrm{C}_{\mathrm{i}}} \tag{1}
\end{equation*}
$$

The value of $C_{1}$ is important, as it directly affects the bass (low-frequency) performance of the circuit. Consider the example where $R_{1}$ is $60 \mathrm{k} \Omega$ and the specification calls for a flat bass response down to 20 Hz . Equation 1 is reconfigured as Equation 2.

$$
\begin{equation*}
\mathrm{C}_{\mathrm{i}}=\frac{1}{2 \pi \mathrm{R}_{\mathrm{i}} \mathrm{f}_{\mathrm{c}}} \tag{2}
\end{equation*}
$$

In this example, $\mathrm{C}_{1}$ is $0.13 \mu \mathrm{~F}$; so, one would likely choose a value of $0.15 \mu \mathrm{~F}$ as this value is commonly used. If the gain is known and is constant, use $R_{1}$ from Table 1 to calculate $C_{1}$. A further consideration for this capacitor is the leakage path from the input source through the input network $\mathrm{C}_{1}$ and the feedback network to the load. This leakage current creates a dc offset voltage at the input to the amplifier that reduces useful headroom, especially in high gain applications. For this reason, a low-leakage tantalum or ceramic capacitor is the best choice. When polarized capacitors are used, the positive side of the capacitor should face the amplifier input in most applications as the dc level there is held at $V_{\text {CLAAP }} / 2$, which is likely higher than the source dc level. Note that it is important to confirm the capacitor polarity in the application. Additionally, lead-free solder can create dc offset voltages and it is important to ensure that boards are cleaned properly.

## Output Low-Pass Filter

If the traces form APA2613 to speaker are short, it doesn't require output filter for FCC \& CE standard.

A ferrite bead may need if it's failing the test for FCC or CE tested without the LC filter. The figure 2 is the sample for added ferrite bead; the ferrite show choosing high impedance in high frequency.


Figure 3. Ferrite Bead Output Filter
Figure 4 and Figure 5 are examples for added the LC filter (Butterworth), it's recommended for the situation that the trace form amplifier to speaker is too long, and needs to eliminate the radiated emission or EMI.


Figure 4. Typical LC Output Filter, Cutoff Frequency of 27 kHz , Speaker Impedance $=8 \Omega$


Figure 5. Typical LC Output Filter, Cutoff Frequency of 27 kHz , Speaker Impedance $=4 \Omega$

## Application Information (Cont.)

## Power-Supply Decoupling Capacitor, C $_{\text {s }}$

The APA2613 is a high-performance CMOS audio amplifier that requires adequate power supply decoupling to ensure the output total harmonic distortion (THD) is as low as possible. Power supply decoupling also prevents the oscillations being caused by long lead length between the amplifier and the speaker.
The optimum decoupling is achieved by using two different types of capacitors that target on different types of noise on the power supply leads. For higher frequency transients, spikes, or digital hash on the line, a good low equivalent-series-resistance (ESR) ceramic capacitor, typically $1 \mu \mathrm{~F}$ placed as close as possible to the device AVDD pin.

## BSN and BSP Capactiors

The full H-bridge output stages use only NMOS transistors. Therefore, they require bootstrap capacitors for the high side of each output to turn on correctly. A 0 . $22 \mu \mathrm{~F}$ ceramic capacitor, rated for at least 25 V , must be connected from each output to its corresponding bootstrap input. Specifically, one $0.22 \mu \mathrm{~F}$ capacitor must be connected from OUTP to BSP, and one $0.22 \mu \mathrm{~F}$ capacitor must be connected from OUTN to BSN.
The bootstrap capacitors connected between the BSP or BSN pins and corresponding output function as a floating power supply for the high-side N -channel power MOSFET gate drive circuitry. During each high-side switching cycle, the bootstrap capacitors hold the gate-to-source voltage high enough to keep the high-side MOSFETs turned on.

## Layout Recommendation

The APA2613 can be used with a small, inexpensive ferrite bead output filter for most applications. However, since the Class-D switching edges are fast, it is necessary to take care when planning the layout of the printed circuit board. The following suggestions will help to meet EMC requirements.
1.The high frequency decoupling capacitors should be placed as close to the PVDD and AVDD terminals as possible. Large ( $100 \mu \mathrm{~F}$ or greater) bulk power supply decoupling capacitors should be placed near the APA2613 on the LPVDD and RPVDD supplies. Local, high-frequency bypass capacitors should be placed as close to the PVDD pins as possible. These caps can be connected to the thermal pad directly for an excellent ground connection. Consider adding a small, good quality low ESR ceramic capacitor between 1000 pF and 10 nF and a larger mid-frequency cap of value between $0.1 \mu \mathrm{~F}$ and $1 \mu \mathrm{~F}$ also of good quality to the PVDD connections at each end of the chip.
2.Keep the current loop from each of the outputs through the ferrite bead and the small filter cap and back to PGND as small and tight as possible. The size of this current loop determines its effectiveness as an antenna.
3.Grounding-The AVDD (pin 7) decoupling capacitor should be grounded to analog ground (AGND). The PVDD decoupling capacitors should connect to PGND. Analog ground and power ground should be connected at the thermal pad, which should be used as a central ground connection or star ground for the APA2613.
4.Output filter-The ferrite EMI filter (Figure 3) should be placed as close to the output terminals as possible for the best EMI performance. The LC filter (Figure 4 and Figure 5) should be placed close to the outputs. The capacitors used in both the ferrite and LC filters should be grounded to power ground.
5.Thermal Pad—The thermal pad must be soldered to the PCB for proper thermal performance and optimal reliability. The dimensions of the thermal pad and thermal land should be 6.46 mm by 2.35 mm . Seven rows of solid vias (three vias per row, $0,3302 \mathrm{~mm}$ or 13 mils diameter) should be equally spaced underneath the thermal land. The vias should connect to a solid copper plane, either on an internal layer or on the bottom layer of the PCB. The vias must be solid vias, not thermal relief or webbed vias.

## Package Information

TSSOP-28P


| $\begin{aligned} & \mathbf{S} \\ & \mathbf{Y} \\ & \mathbf{M} \\ & \mathbf{B} \\ & \mathbf{O} \end{aligned}$ | TSSOP-28P |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MILLIMETERS |  | INCHES |  |
|  | MIN. | MAX. | MIN. | MAX. |
| A |  | 1.20 |  | 0.047 |
| A1 | 0.05 | 0.15 | 0.002 | 0.006 |
| A2 | 0.80 | 1.05 | 0.031 | 0.041 |
| b | 0.19 | 0.30 | 0.007 | 0.012 |
| c | 0.09 | 0.20 | 0.004 | 0.008 |
| D | 9.60 | 9.80 | 0.378 | 0.386 |
| D1 | 4.50 | 6.00 | 0.177 | 0.236 |
| E | 6.20 | 6.60 | 0.244 | 0.260 |
| E1 | 4.30 | 4.50 | 0.169 | 0.177 |
| E2 | 2.50 | 3.50 | 0.098 | 0.138 |
| e | 0.65 BSC |  | 0.026 BSC |  |
| L | 0.45 | 0.75 | 0.018 | 0.030 |
| $\theta$ | $0^{\circ}$ | $8{ }^{\circ}$ | $0^{\circ}$ | $8{ }^{\circ}$ |

Note : 1. Followed from JEDEC MO-153 AET.
2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
3. Dimension "E1" does not include inter-lead flash or protrusions. Inter-lead flash and protrusions shall not exceed 10 mil per side.

## Package Information

QFN4x4-28


| $\begin{aligned} & \text { S } \\ & \text { Y } \\ & \text { M } \\ & \text { B } \end{aligned}$ | QFN4x4-28 |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MILLIMETERS |  | INCHES |  |
|  | MIN. | MAX. | MIN. | MAX. |
| A | 0.80 | 1.00 | 0.031 | 0.039 |
| A1 | 0.00 | 0.05 | 0.000 | 0.002 |
| A3 | 0.20 REF |  | 0.008 REF |  |
| b | 0.17 | 0.27 | 0.007 | 0.011 |
| D | 3.90 | 4.10 | 0.154 | 0.161 |
| D2 | 2.10 | 2.50 | 0.083 | 0.098 |
| E | 3.90 | 4.10 | 0.154 | 0.161 |
| E2 | 2.10 | 2.50 | 0.083 | 0.098 |
| e | 0.45 BSC |  | 0.016 BSC |  |
| L | 0.35 | 0.45 | 0.014 | 0.018 |
| K | 0.20 |  | 0.008 |  |

## Carrier Tape \& Reel Dimensions



| Application | A | H | T1 | C | d | D | W | E1 | F |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| QFN4x4-28 | $330.0 \pm 2.00$ | 50 MIN . | $\begin{array}{r} 12.4+2.00 \\ -0.00 \end{array}$ | $\begin{array}{r} 13.0+0.50 \\ -0.20 \end{array}$ | 1.5 MIN. | 20.2 MIN. | $12.0 \pm 0.30$ | $1.75 \pm 0.10$ | $5.5 \pm 0.05$ |
|  | P0 | P1 | P2 | D0 | D1 | T | A0 | B0 | K0 |
|  | $4.0 \pm 0.10$ | $8.0 \pm 0.10$ | $2.0 \pm 0.05$ | $\begin{array}{r} 1.5+0.10 \\ -0.00 \end{array}$ | 1.5 MIN. | $0.6+0.00$ -0.40 | $4.30 \pm 0.20$ | $4.30 \pm 0.20$ | $1.30 \pm 0.20$ |

(mm)

## Devices Per Unit

| Package Type | Unit | Quantity |
| :---: | :---: | :---: |
| QFN4x4-28 | Tape \& Reel | 3000 |

## Carrier Tape \& Reel Dimensions



| Application | A | H | T1 | C | d | D | W | E1 | F |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TSSOP-28P | 330.0+2.00 | 50 MIN . | $16.4+2.00$ -0.00 | $13.0+0.50$ -0.20 | 1.5 MIN. | 20.2 MIN. | $16.0 \pm 0.30$ | $1.75 \pm 0.10$ | $7.50 \pm 0.10$ |
|  | P0 | P1 | P2 | D0 | D1 | T | A0 | B0 | K0 |
|  | $4.00 \pm 0.10$ | $12.00 \pm 0.10$ | $2.00 \pm 0.10$ | $\begin{array}{r} 1.5+0.10 \\ -0.00 \end{array}$ | 1.5 MIN. | $\begin{array}{r} 0.6+0.00 \\ -0.40 \end{array}$ | $6.9 \pm 0.20$ | $10.20 . \pm 0.20$ | $1.50 \pm 0.20$ |

(mm)

## Devices Per Unit

| Package Type | Unit | Quantity |
| :---: | :---: | :---: |
| TSSOP-28P | Tape \& Reel | 2000 |

## APA2613

## Taping Direction Information

TSSOP-28P

QFN4x4-28


## Classification Profile



## Classification Reflow Profiles

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
| :---: | :---: | :---: |
| Preheat \& Soak <br> Temperature min ( $\mathrm{T}_{\text {smin }}$ ) <br> Temperature max ( $\mathrm{T}_{\text {smax }}$ ) <br> Time ( $\mathrm{T}_{\text {smin }}$ to $\mathrm{T}_{\text {smax }}$ ) ( $\mathrm{t}_{\mathrm{s}}$ ) | $\begin{gathered} 100^{\circ} \mathrm{C} \\ 150^{\circ} \mathrm{C} \\ 60-120 \text { seconds } \end{gathered}$ | $\begin{gathered} 150^{\circ} \mathrm{C} \\ 200^{\circ} \mathrm{C} \\ 60-120 \text { seconds } \end{gathered}$ |
| Average ramp-up rate ( $\mathrm{T}_{\text {smax }}$ to $\mathrm{T}_{\mathrm{P}}$ ) | $3^{\circ} \mathrm{C} /$ second max. | $3^{\circ} \mathrm{C} /$ second max. |
| Liquidous temperature ( $\mathrm{T}_{\mathrm{L}}$ ) Time at liquidous (tı) | $\begin{gathered} 183{ }^{\circ} \mathrm{C} \\ 60-150 \text { seconds } \end{gathered}$ | $\begin{gathered} 217^{\circ} \mathrm{C} \\ 60-150 \text { seconds } \end{gathered}$ |
| Peak package body Temperature $\left(T_{p}\right)^{*}$ | See Classification Temp in table 1 | See Classification Temp in table 2 |
| Time ( $t_{p}$ )** within $5^{\circ} \mathrm{C}$ of the specified classification temperature ( $\mathrm{T}_{\mathrm{c}}$ ) | 20** seconds | 30** seconds |
| Average ramp-down rate ( $T_{p}$ to $T_{\text {smax }}$ ) | $6^{\circ} \mathrm{C} /$ second max. | $6^{\circ} \mathrm{C} /$ second max. |
| Time $25^{\circ} \mathrm{C}$ to peak temperature | 6 minutes max. | 8 minutes max. |
| * Tolerance for peak profile Temperature ( $T_{p}$ ) is defined as a supplier minimum and a user maximum. <br> ** Tolerance for time at peak profile temperature ( $t_{p}$ ) is defined as a supplier minimum and a user maximum. |  |  |

Table 1. SnPb Eutectic Process - Classification Temperatures (Tc)

| Package <br> Thickness | Volume $\mathbf{m m}^{\mathbf{3}}$ <br> $<350$ | Volume $\mathbf{~ m m}^{3}$ <br> $\geq \mathbf{3 5 0}$ |
| :---: | :---: | :---: |
| $<2.5 \mathrm{~mm}$ | $235^{\circ} \mathrm{C}$ | $220^{\circ} \mathrm{C}$ |
| $\geq 2.5 \mathrm{~mm}$ | $220^{\circ} \mathrm{C}$ | $220^{\circ} \mathrm{C}$ |

Table 2. Pb-free Process - Classification Temperatures (Tc)

| Package <br> Thickness | Volume $^{\mathbf{m m}^{\mathbf{3}}}$ <br> $<\mathbf{3 5 0}$ | Volume $\mathbf{~ m m}^{\mathbf{3}}$ <br> $\mathbf{3 5 0 - 2 0 0 0}$ | Volume $\mathbf{m m}^{\mathbf{3}}$ <br> $>\mathbf{2 0 0 0}$ |
| :---: | :---: | :---: | :---: |
| $<1.6 \mathrm{~mm}$ | $260^{\circ} \mathrm{C}$ | $260^{\circ} \mathrm{C}$ | $260^{\circ} \mathrm{C}$ |
| $1.6 \mathrm{~mm}-2.5 \mathrm{~mm}$ | $260^{\circ} \mathrm{C}$ | $250^{\circ} \mathrm{C}$ | $245^{\circ} \mathrm{C}$ |
| $\geq 2.5 \mathrm{~mm}$ | $250^{\circ} \mathrm{C}$ | $245^{\circ} \mathrm{C}$ | $245^{\circ} \mathrm{C}$ |

## Reliability Test Program

| Test item | Method | Description |
| :--- | :--- | :--- |
| SOLDERABILITY | JESD-22, B102 | $5 \mathrm{Sec}, 245^{\circ} \mathrm{C}$ |
| HOLT | JESD-22, A108 | $1000 \mathrm{Hrs}, \mathrm{Bias}$ @ $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |
| PCT | JESD-22, A102 | $168 \mathrm{Hrs}, 100 \% \mathrm{RH}, 2 \mathrm{~atm}, 121^{\circ} \mathrm{C}$ |
| TCT | JESD-22, A104 | $500 \mathrm{Cycles},-65^{\circ} \mathrm{C} \sim 150^{\circ} \mathrm{C}$ |
| HBM | MIL-STD-883-3015.7 | VHBM $\geqq 2 \mathrm{KV}$ |
| MM | JESD-22, A115 | VMM $\geqq 200 \mathrm{~V}$ |
| Latch-Up | JESD 78 | $10 \mathrm{~ms}, 1_{\mathrm{tr}} \geqq 100 \mathrm{~mA}$ |

## APA2613

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